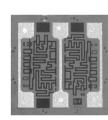
Vishay Electro-Films

Nichrome Thin Film, Center-Tapped Resistors





Product may not be to scale

The CTN series is a center tapped nichrome resistor chip providing excellent stability at 250mW power levels. The CTN offers the designer flexibility in use as either a single value resistor or as two resistors with a center tap feature. The CTNs six bonding pads allows the user increased layout flexibility.

The CTNs are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The CTNs are 100% electrically tested and visually inspected to MIL-STD-883.

FEATURES

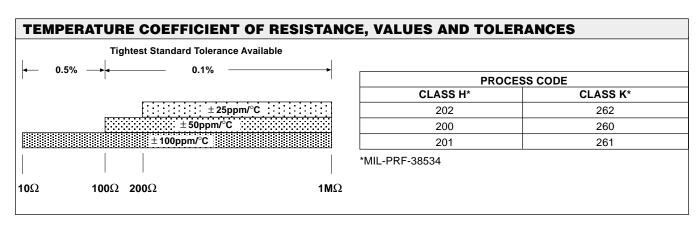
- · Center tap feature
- Chip size: 0.030 inches square
- Resistance range total: 10Ω to $1M\Omega$
- Ratio tolerances to: 0.1%
- · Resistor material: nichrome
- Oxidized silicon substrate for good power dissipation

APPLICATIONS

The CTN center-tapped resistor chips are used mainly in feedback circuits of amplifiers where ratio matching, high power and tracking between two resistors is critical.

Recommended for Hermetic environment where die is not exposed to moisture.

For low values, the resistance of the six bonding-pad configurations can vary, depending on the method of measurement used. Vishay EFI measures low-value resistors by the four wire Kelvin technique.



STANDARD ELECTRICAL SPECIFICATIONS		
PARAMETER		
TCR tracking between halves (R _A ,R _B)	± 2ppm/°C*	
Center tap ratio, R _A /R _B tolerance	1 ± 1% standard	
Noise, MIL-STD-202, Method 308 100Ω - $250k\Omega$	- 35dB typical	
Stability, 1000 hours, + 125°C, 125mW	± 0.1% ΔR/R	
Operating temperature range	- 55°C to + 125	
Dielectric voltage breakdown	200V	
Insulation resistance	10 ¹² minimum	
Operating voltage	100V maximum	
DC power rating at + 70°C (derated to zero at + 175°C)	250mW	

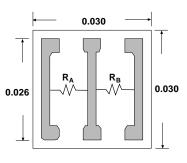
20ppm/°C for R < 20

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Nichrome Thin Film, Center-Tapped Resistors Vishay Electro-Films

CONFIGURATIONS in inches

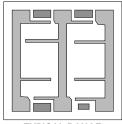


STANDARD CONFIGURATION

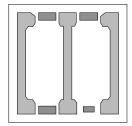
Six locations. All pads 0.005 x 0.005 inch



TYPICAL RANGE 10 Ω - 49 Ω

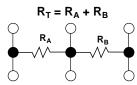


TYPICAL RANGE $\mathbf{50}\Omega$ - $\mathbf{199}\Omega$



TYPICAL RANGE 200 Ω - 1M Ω

SCHEMATIC



MECHANICAL SPECIFICATIONS in inches			
PARAMETER			
Chip size	0.030 x 0.030 ± 0.002 (0.762 x 0.762 ± 0.05mm)		
Chip thickness	$0.010 \pm 0.002 \ (0.254 \pm 0.05 \text{mm})$		
Chip substrate material	Oxidized silicon, 10kÅ minimum SiO ₂		
Resistor material	Nichrome		
Bonding pad size	0.005 x 0.005 (0.127 x 0.127mm) minimum		
Number of pads	6		
Pad material	15kÅ minimum gold standard		
Backing	None, lapped semiconductor silicon		

OPTIONS:

Alphanumeric part parking, up to six characters Gold backing for eutectic die attach Center-tap ratio tolerances to 0.01% Contact Applications Engineer

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•	100% visualied,	$10kΩ$, $\pm 1\%$, ± 100 ppm/°C		Class H
P/N:	W	CTN	201	1

100% visualied, 10ks2,	± 1%, ± 100pp	m/ C TCR, Gold Pads,	Class n			
W	CTN	201	1000	1	F	
INSPECTION	PRODUCT	PROCESS	RESISTANCE	MULTIPLIER	TOLERANCE	
/PACKAGING	FAMILY	CODE	VALUE	CODE	CODE	
N = 100% visually		See Process Code	Use first 4	$\mathbf{C} = 0.001$	B =0.1%	
nspected parts per		table	significant digits	B = 0.01	C =0.2%	
MIL-STD-883 loaded			of resistance (R_T)	A = 0.1	D = 0.5%	
n matrix tray				0 = 1	F = 1.0%	
K = Sample, visually				1 = 10	G = 2.0%	
nspected loaded in matr	ix			2 = 100	H = 2.5%	
rays (4% AQL)				3 = 1000	J = 5.0%	
				4 = 10000	K = 10%	
					M = 20%	
					L = 25%	
	W INSPECTION /PACKAGING W = 100% visually nspected parts per MIL-STD-883 loaded n matrix tray S = Sample, visually nspected loaded in matr	W CTN INSPECTION PRODUCT /PACKAGING FAMILY N = 100% visually nspected parts per MIL-STD-883 loaded n matrix tray K = Sample, visually nspected loaded in matrix	W CTN 201 INSPECTION PRODUCT PROCESS /PACKAGING FAMILY CODE N = 100% visually See Process Code table will-STD-883 loaded matrix tray K = Sample, visually inspected loaded in matrix	$\begin{array}{llllllllllllllllllllllllllllllllllll$	W CTN 201 1000 1 INSPECTION /PACKAGING PRODUCT FAMILY PROCESS CODE RESISTANCE VALUE MULTIPLIER CODE V = 100% visually nspected parts per MIL-STD-883 loaded n matrix tray See Process Code table Use first 4 Use first 4 Significant digits of resistance (R _T) B = 0.01 OF TAMES (R_T) X = Sample, visually nspected loaded in matrix rays (4% AQL) 1 = 10 OF TAMES (R_T) 2 = 100 OF TAMES (R_T)	W

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